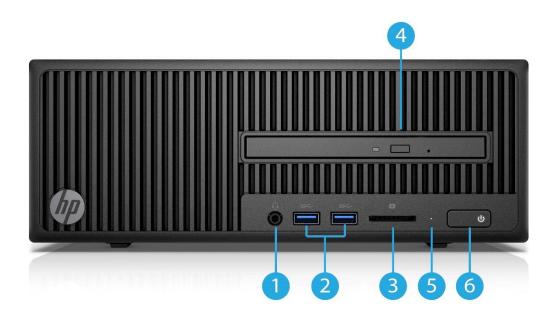
Overview

HP 280 G2 Small Form Factor Business PC



Front

- 1. Microphone/Headphone Combo Jack
- 2. (2) USB 3.0 Ports
- 3. 3-in1 SD Media Card Reader
- 4. Slim-height Bay supporting an optical disk drive (optional)
- 5. PC Status LED
- 6. Power Button

Not Shown

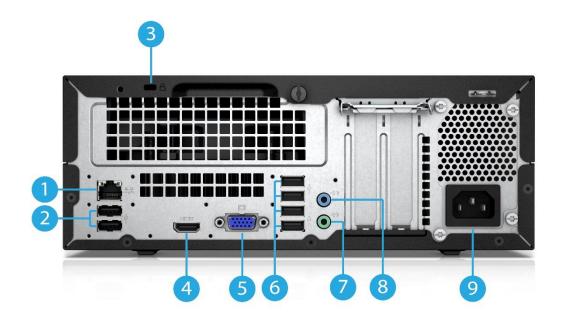
Slots (1) PCI Express x16 Graphics Connector

(1) PCI Express x1 Accessory Connector

Bays (1) 3.5" internal storage drive bay

Overview

HP 280 G2 Small Form Factor Business PC



<u>Back</u>

- 1. RJ-45 Network Connector
- 2. (2) USB 2.0 Ports
- 3. Security Lock Slot
- 4. HDMI Port
- 5. VGA Port

- 6. (4) USB 2.0 Ports
- 7. Audio Line Out
- 8. Audio Line In
- 9. Power Cord Connector

Overview

AT A GLANCE

- Windows 10 Pro , Windows 10 Home, NeoKylin Linux (select countries only) or FreeDOS 2.0 operating systems
- Intel® H110 chipset supporting Intel® 7th & 6th generation Intel® Celeron®, Pentium®, Core™ i3 ,i5, i7 processors featuring Intel® HD Graphics
- Supports an optional discrete graphics card
- Integrated 10/100/1000 Ethernet Controller
- Supports Wake-on-LAN (WOL)
- Up to 32GB DDR4 Unbuffered Memory (UDIMM)
- Supports both Hard Disk and Solid State Drives
- Independent monitor support via VGA video interfaces
- TPM 2.0 support (firmware)
- High definition audio
- 8 USB ports (including 2-USB 3.0 ports)
- 3-in1 SD Media Card Reader
- 180W energy efficient internal power supply
- Security cable lock supported (sold separately)
- Protected by HP Services; terms and conditions vary by country; certain restrictions and exclusions apply

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Standard Features and Configurable Modules

OPERATING SYSTEMS

Preinstalled (Windows)

Windows 10 Pro 64* Windows 10 Home 64*

Pre-installed (Other)

FreeDOS 2.0

NeoKylin Linux 64-bit Commercial OS (select countries only)

Web-supported

Windows 10 Pro 64 Windows 10 Home 64

*Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on this product or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Intel® H110 Chipset

PROCESSOR*

Intel® Celeron®

Intel® Celeron® G3900 with Intel® HD Graphics 510 (2.8 GHz, 2 MB cache, 2 cores)

Intel® Celeron®

Intel® Celeron® G3930 with Intel® HD Graphics 610 (2.9 GHz, 2 MB cache, 2 cores)

Intel® Pentium®

Intel® Pentium® G4400 with Intel® HD Graphics 510 (3.3 GHz, 3 MB cache, 2 cores)

Intel® Pentium®

Intel® Pentium® G4560 with Intel® HD Graphics 610 (3.5 GHz, 3 MB cache, 2 cores)

Intel® Core™i3

Intel® Core™ i3-6100 with Intel® HD Graphics 530 (3.7 GHz, 3 MB cache, 2 cores)

Intel® Core™i3

Intel® Core™ i3-7100 with Intel® HD Graphics 630 (3.9 GHz, 3 MB cache, 2 cores)

Intel® Core™ i5

Intel® Core™ i5-6500 with Intel® HD Graphics 530 (3.2 GHz, 6 MB cache, 4 cores)

Intel® Core™ i5



Standard Features and Configurable Modules

Intel® Core™ i5-7500 with Intel® HD Graphics 630 (3.4 GHz, 6 MB cache, 4 cores)

Intel® Core™ i7

Intel® Core™ i7-7700 with Intel® HD Graphics 630 (3.6 GHz, 8 MB cache, 4 cores)

*Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.



Standard Features and Configurable Modules

MEMORY*

Both slots are customer accessible / upgradeable, Supports Dual Channel Memory

Form FactorTypeMaximum# of SlotsSmall Form FactorDDR4-2133 for SkyLake CPUS32 GB capacity2 DIMM

(Transfer rates up to 2133

MT/s)

DDR4-2400 for KabyLake CPUS (Transfer rates up to

2400 MT/s)

2GB DDR4-2133 DIMM (1x2GB) 4GB DDR4-2133 DIMM (1x4GB) 8GB DDR4-2133 DIMM (1x8GB)

8GB DDR4-2133 DIMM (2x4GB) (Dual Channel)

2GB DDR4-2400 UDIMM (1x2GB) 4GB DDR4-2400 UDIMM (1x4GB)

8GB DDR4-2400 UDIMM (1x8GB)

*NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system. Memory modules support data transfer rates up to 2133 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

STORAGE*

SATA 3.5" 6Gb/s HDDs*

500GB 7200 RPM SATA Hard Disk Drive 1TB 7200 RPM SATA Hard Disk Drive

Solid State Drives 2.5" *

128GB SATA Value SSD

SD Card Reader**

3-in1 SD Media Card Reader

*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

**Card sold separately

OPTICAL DISC DRIVES*

HP 9.5mm Desktop G2 Slim DVD-ROM Drive

HP 9.5mm Desktop G2 Slim DVD Writer Drive

*Optical drives are optional or add on features. Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives.



Standard Features and Configurable Modules

GRAPHICS

Integrated

Intel® Integrated HD Graphics Varies by Processor **Discrete** (optional for selected countries only)
NVIDIA® GeForce® GT 730 2GB PCIe x8



Standard Features and Configurable Modules

AUDIO/MULTIMEDIA

HD audio with Realtek ALC3252 Audio Codec Combo Microphone/Headphone Jack Line-out and Line-in rear port (3.5mm)

NETWORKING

Ethernet (RJ-45)

Integrated 10/100/1000M Gigabit Ethernet Controller with Realtek RTL8111HSH -CG

Supports Wake-on-LAN (WOL)

Wireless*

Intel® 3168 802.11ac with PCIe x1 WLAN/ Bluetooth® Combo*® Intel® 3168 802.11ac with PCIe x1 WLAN/ Bluetooth® Combo*® Disabled

* Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited.

PORTS

Front I/O Ports

Two (2) USB 3.0 ports

One (1) Microphone/Headphone Combo Jack

Rear I/O Ports

Six (6) USB 2.0 ports

One (1) RJ45 network connection

One (1) Audio Line out

One (1) Audio Line in

One (1) VGA

One (1) HDMI

Internal I/O Ports

One (1) PCIe x 16 (3.0)

One (1) PCIe x 1 (2.0)

BAYS

One (1) 1st 3.5" Hard Disc Drive Bay

One (1) 9.5mm Slim ODD Bay

One (1) Secure Digital (SD) Reader Bay

KEYBOARDS AND POINTING DEVICES*

Keyboards

Business Slim USB Antimicrobial Standalone Wired Keyboard HP USB Business Slim Keyboard

Mice



Standard Features and Configurable Modules

HP USB Mouse (China only)
HP USB Mouse

*Keyboards and mouse are optional or add-on features.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Preinstalled (varies by country)

BIOS

Power On Authentication

Multimedia

Cyberlink Power Media Player Cyberlink Power2Go (Secure Burn)

HP Value Add Software

HP ePrint Driver¹ HP Recovery Manager HP Support Assistant Windows 10 Welcome App

3rd Party

Foxit PhantomPDF Express for HP (optional, US only)

Microsoft Products

Buy Office Bing Search Skype

Manageability

Discover HP Touchpoint Manager²

SECURITY FEATURES

Trusted Platform Module (TPM) 2.0 (firmware)

1.TPM feature will not be supported on machines pre-configured with FreeDOS/Linux 2.In selected countries, machines pre-configured with Windows OS will be shipped with TPM disabled.

Security cable slot

POWER SUPPLY*

180 W, up to 85% efficient

*Note: All power supplies are not available in every region.



Standard Features and Configurable Modules

DIMENSIONS AND WEIGHT (configured with 1 HDD and 1 ODD)

Chassis 11.42 x 10.63 x 3.94 in (**D** x **W** x **H**) 290 x 270 x 100 mm

System Weight 8.88 lbs / 4.03 kg (for 3.5" HDD)

8. 07 lbs / 3.66 kg (for 2.5" SSD)

PACKAGING DIMENSIONS AND WEIGHT

Dimensions 19.65 x 15.71 x 8.98 in (499 x 399 x 228 mm)

Weight 15.5 lbs /7.03 kg (for 3.5" HDD)

14.68 lbs /6.66 kg (for 2.5" SSD)

PALLETIZATION AND CONTAINER

Type Normal 40'G container

Pallet Size 47.24 x 39.37 x 4.96 in

1200 x 1000 x 126 mm

Pallet Profile 1 product/carton

6 cartons/layer

9 layers/pallet Total = 54 pcs per pallet

Pallet Size Loaded 47.24 x 39.37 x 86.81in

1200 x 100 x 2205 mm

Container Profile 21 pallets/40'G container

Product Quantity per Container 54 x 21 = 1134 pcs

UNIT ENVIRONMENT AND OPERATING CONDITIONS

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign
 matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Altitude (unpressurized) Operating: 10,000 ft (3048 m)

Non-operating: 30,000 ft (9144 m)



Standard Features and Configurable Modules

* Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	labeled with one or more of t	hese marks: stered in the United States. See ht	to the following approvals and may be tp://www.epeat.net for registration
System Configuration	slim Desktop model is based		red Noise Emissions data for the Ultra- ring a hard disk drive, a high efficiency
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	16.11 W	16.06 W	16.47 W
Short idle)			
Normal Operation Long idle)	15.28 W	15.16 W	15.23 W
Sleep	1.19 W	1.13 W	1.06 W
Off	0.74 W	0.74 W	0.74 W
	family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific ® compliant configurations, then e	t product if offered within the model e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft
	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR typically configured PC featu Windows® operating system.	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific ® compliant configurations, then e ring a hard disk drive, a high effici	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft
	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR' typically configured PC featu Windows® operating system.	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific © compliant configurations, then e ring a hard disk drive, a high effici 230VAC, 50Hz	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz
Normal Operation	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR' typically configured PC featu Windows® operating system. 115VAC, 60Hz 55 BTU/hr	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific © compliant configurations, then e ring a hard disk drive, a high effici 230VAC, 50Hz 55 BTU/hr	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft
Normal Operation Short idle) Normal Operation Long idle)	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR' typically configured PC featu Windows® operating system.	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific © compliant configurations, then e ring a hard disk drive, a high effici 230VAC, 50Hz	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz
Normal Operation (Short idle) Normal Operation (Long idle) Sleep	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR typically configured PC featu Windows® operating system. 115VAC, 60Hz 55 BTU/hr 52 BTU/hr	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific compliant configurations, then ering a hard disk drive, a high efficiency and the state of the s	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz 56 BTU/hr 52 BTU/hr
Normal Operation (Short idle) Normal Operation (Long idle)	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR' typically configured PC featu Windows® operating system. 115VAC, 60Hz 55 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific compliant configurations, then exing a hard disk drive, a high efficiency and the state of the s	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz 56 BTU/hr
(Short idle) Normal Operation (Long idle) Sleep	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR typically configured PC featu Windows® operating system. 115VAC, 60Hz 55 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is ca	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific compliant configurations, then exing a hard disk drive, a high efficiency and the state of the s	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz 56 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR typically configured PC featu Windows® operating system. 115VAC, 60Hz 55 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is ca attained for one hour.	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific compliant configurations, then exing a hard disk drive, a high efficiency and the state of the s	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz 56 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions (in accordance with	Energy efficiency data listed family . HP computers marke Environmental Protection Ag does not offer ENERGY STAR typically configured PC featu Windows® operating system. 115VAC, 60Hz 55 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is ca attained for one hour.	d with the ENERGY STAR® Logo ar ency (EPA) ENERGY STAR® specific compliant configurations, then exing a hard disk drive, a high efficiency and the state of the s	e compliant with the applicable U.S. cations for computers. If a model family energy efficiency data listed is for a ency power supply, and a Microsoft 100VAC, 60Hz 56 BTU/hr 52 BTU/hr 4 BTU/hr 3 BTU/hr vatts, assuming the service level is



Standard Features and Configurable Modules

	1				
Longevity and Upgrading		an be upgraded, possibly extending its useful life by seven enents contained in the product may include:	eral years. Upgradeable features		
	6 USB port	c			
	• 2 memory				
		half-length slot			
	• 1 MXM 3.0	Type A - 35W slot			
	1 mSATA s				
		rnal bay supporting up to Two 2.5" hard drives (HDD/SSD/ ernal supporting optical drive	(SED/SSHD)		
	Spare parts an production.	re available throughout the warranty period and or for up	to "5" years after the end of		
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC			
	Ratteries used	d in the product do not contain:			
		reater the1ppm by weight			
	-	greater than 20ppm by weight			
	_	CR2032 (coin cell)			
	Battery type:	Lithium			
Additional	• This	product is in compliance with the Restrictions of Hazardo	us Substances (RoHS) directive -		
Information		/65/EC.			
		HP product is designed to comply with the Waste Electrica	al and Electronic Equipment		
		E) Directive – 2002/96/EC.	or resident of extra position		
		product is in compliance with California Proposition 65 (Si er and Toxic Enforcement Act of 1986).	tate of California; Safe Drinking		
		product is in compliance with the IEEE 1680 (EPEAT) stand	dard at the soulds level see		
		epeat.net	dara de tric "gota" tevet, see		
		ics parts weighing over 25 grams used in the product are	marked per ISO11469 and		
	IS01		·		
		product contains 5.7% post-consumer recycled plastic (b			
	• This	product is 92.2% recycle-able when properly disposed of	at end of life.		
Packaging Materials	External:	PAPER/Corrugated	1300 g		
r ackaging riaccitate	Internal:	PLASTIC/EPE-Expanded Polyethylene	129.6 g		
		PLASTIC/EPS (Expanded Polystyrene)	133.6 g		
		PLASTIC/Polyethylene low density	21.76 g		
		ackaging material contains at least 5% recycled content.			
	The corrugat	ed paper packaging materials contains at least 30.66% re	ecycled content.		
Common to all					
Form Factors					
Material Usage		does not contain any of the following substances in exces	s of regulatory limits (refer to the		
	HP General Specification for the Environment at				
	http://www.h	p.com/hpinfo/globalcitizenship/environment/pdf/gse.pd	T):		
	• Asbe	ctns			
		stos nin Azo Colorants			
		in A20 Colorants in Brominated Flame Retardants – may not be used as fla	ame retardants in plastics		
	• Cadn	-	and retardants in plastics		
		inated Hydrocarbons			
		rinated Paraffins			

Standard Features and Configurable Modules

	 Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

Standard Features and Configurable Modules

CERTIFICATIONS

EPEAT® Silver*

CECP

SEPA

WEEE (Waste, Electric and electronic equipment)

ENERGY STAR® 6.1

CEL

FCC

UL

RoHS

*EPEAT® registered where applicable/supported. EPEAT registration varies by country. See www.epeat.net for registration status by country.

SERVICE AND SUPPORT

On-site Warranty: One-year (1-1-1) or Three-year (3-3-3) limited warranty delivers three years of on-site, next business day² service for parts and labor and complimentary limited technical support. One-year/Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack.⁴ To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/qo/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical support applies only to HP-configured and third-party HP qualified hardware and software.

NOTE 4: Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications - Graphics

GRAPHICS

HDMI	Multimode capable; supports HDCP, HDMI Audio (2 streams), HBR2 link rates and Multi- Stream Technology for a maximum of 3 displays (including the integrated panel)				
Maximum Graphics Memory	Microsoft Windows 7	Windows 8.1	Windows 10		
	Up to 1.7GB	Up to 1.8GB	>4 GB		
		Note: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.			
Maximum Color Depth	24/30/36				
Graphics/Video API Support	playback and enhancem o Encode/transco o Playback of hig o Superior image • DirectX Video Accelerati o Full AVC/VC1/M • Advanced Scheduler 2.0	Elear Video Technology HD Suj ent features that improve the ode HD content h definition content including quality with sharper, more co on (DXVA) support for acceler IPEG2/HEVC HW Decode , 1.0 1, Windows 10, Linux OS Supp raphics 510)	e end user's viewing experience Blu-ray Disc blorful images ating video processing		

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz

Technical Specifications - Graphics

NVIDIA® GeForce® GT 730 2GB PCIe x8 Graphics Card

Get impressive graphics and high resolution dual-display performance in a low profile, PCI Introduction

Express x8 graphics add-in card based on the NVIDIA® Kepler™ Graphics Processor. Improve your

everyday PC, Web conferencing, and video or photo editing.

Memory 2GB DDR3 64-bit wide frame buffer operating at 900 MHz

NVIDIA® Kepler™ GPU operating at 902 MHz **Controller Clock Speed**

Multi-display Support A maximum of 4 displays are supported by the card.

Supports Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2 APIs, Shade Model 5, UVD 4.2, VCE 2.0, **Graphics / API support**

and DirectCompute 11

1 x Dual-Link DVI-I, 1x DisplayPort; Includes DVI to VGA adapter

Output Connectors Display Port output is multi-mode capable, support Audio, HBR2 and MST

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate*	VGA (DVI-VGA adanter)	DVI-D	DisplayPort	Standard
640 x 480	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Х	IBM VGA
800 x 600	60, 75, 85	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Х	Х	Х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	Х	Х	Х	VESA DMT
1440 x 900	60, 60RB	Х	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	Х	VESA DMT, 1.92M3

Technical Specifications - Graphics

1920 x 1440	60, 75, 85	х	l x	х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75	Х	Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25			X	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
			V	X	·
3840 x 2160	30		Х	X	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	VESA (SMPTE 274M)
1920 x 1080	50		Х	Х	SMPTE 274M
1920 x 1080	30		Х	Х	SMPTE 274M
1920 x 1080	24		Х	Х	SMPTE 274M
1280 x 720	60		Х	Х	VESA (CEA-770.3)
1280 x 720	50		Х	Х	SMPTE 296M
720 x 480	60		Х	Х	MHL (CEA-770.2)
720 x 576	50		Х	Х	ITU-R BT.1358
640 x 480	60		Х	Х	CEA (VESA DMT)

^{* &}gt;60 refresh rates only for analog (VGA) signaling

Technical Specifications – Hard Disk and Solid State Storage

1TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive				
Capacity	1,000,204,886,016 byt	es		
Rotational Speed	7,200 rpm			
Interface	Serial ATA 3.0 (6.0 Gb/s	5)		
Buffer Size	32 MB	32 MB		
Logical Blocks	1,953,525,168			
Cook Thurs (Associations de	Single Track:	2.0 ms		
Seek Time (typical reads, includes controller overhead, including settling)	Average:	11 ms		
including settling)	Full-Stroke:	21 ms		
Height (nominal)	1 in/2.54 cm	1 in/2.54 cm		
Intidale (no project)	Media diameter: 3.5 in/8.89 cm			
Width (nominal)	Physical size: 4 in/10.2	cm		
Operating Temperature	41° to 131° F (5° to 55°	41° to 131° F (5° to 55° C)		

NOTE: "For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software."

500GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive				
Capacity	500,107,862,016 bytes	500,107,862,016 bytes		
Rotational Speed	7,200 rpm	7,200 rpm		
Interface	Serial ATA 3.0 (6.0 Gb/s)	Serial ATA 3.0 (6.0 Gb/s)		
Buffer Size	16 MB			
Logical Blocks	976,773,168			
	Single Track:	2.0 ms		
Seek Time (typical reads, includes controller overhead,	Average:	11 ms		
including settling)	Full-Stroke: 21 ms			
Height (nominal)	1 in/2.54 cm			



Technical Specifications – Hard Disk and Solid State Storage

Maridah (manainal)	Media diameter: 3.5 in/8.89 cm	
Width (nominal)	Physical size: 4 in/10.2 cm	
Operating Temperature	41° to 131° F (5° to 55° C)	

NOTE: "For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software."

128GB SATA 2.5" Value (No	n-SED) Solid State Driv	ve		
Unformatted Capacity	128 GB	128 GB		
Architecture	TLC NAND Flash			
Interface	SATA 3.2 (6.0 Gb/s)			
Form Factor	2.5 inch			
Dimensions (W x H x D)	6.98 x 0.7 x 10.05 cm			
Weight	31g			
Bandwidth Performance	Sustained Sequential Up to 510 MB/s Read:			
	Sustained Sequential Write:	Up to 330 MB/s		
	Random Read: Up to 38K IOPs			
	Random Write:	Random Write: Up to 70K IOPs		
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p		
	Total power consumption:	-		
Useful Drive Life	72TB written, up to 40GB/	day for 5 years		
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	

NOTE: "For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows10) of system disk is reserved for the system recovery software."



Technical Specifications - Removable Storage

HP 9.5mm Desktop G2	Slim DVD Writer Drive	2		
Height	9.5 mm height			
Orientation	Either horizontal or vertical			
Interface type	SATA/ATAPI			
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB sta	andard		
Dimensions (W x H x D)	5.04 x 0.37 x 5.0 in (128 x 9.	5 x 127 mm) without bezel		
Weight (max)	0.31 lb (140 g)			
	DVD-R DL	Up to 6X		
	DVD+R	Up to 8X		
	DVD+RW	Up to 8X		
	DVD+R DL	Up to 6X		
	DVD-R	Up to 8X		
	DVD-RW	Up to 6X		
	CD-R	Up to 24X		
	CD-RW	Up to 10X		
	DVD-RW, DVD+RW	Up to 8X		
	DVD-R DL, DVD+R DL	Up to 8X		
	DVD+R, DVD-R Up to 8X			
	DVD-ROM DL, DVD-ROM	Up to 8X		
	CD-ROM, CD-R	Up to 24X		
	CD-RW	Up to 24X		
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)		
(typical reads, including	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)		
settling)	Stop Time	6 seconds (typical)		
	Source	Slimline SATA DC power receptacle		
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p		
Power				
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)		
	Temperature	41° to 122° F (5° to 50° C)		
Environmental conditions	Relative Humidity	10% to 80%		
(operating - non-condensing)	Maximum Wet Bulb Temperature	84° F (29° C)		
HP 9.5mm Desktop G2	Slim DVD-ROM Drive			
Height	9.5mm			

Technical Specifications - Removable Storage

Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Dimensions (W x H x D)	5.04 x 0.37 x 5.0 in (128 x 9.5	x 127 mm) without bezel	
Weight (max)	Up to 0.31 lb (140g) without bezel		
	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
Read speeds	DVD-ROM	Up to 8X	
-	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum	
	Temperature	41° to 122° F (5° to 50° C)	
Environmental (all conditions	Relative Humidity	10% to 80%	
non-condensing)	Maximum Wet Bulb Temperature (operating)	84° F (29° C)	



Technical Specifications - Audio

High Definition Audio			
Туре	Integrated		
HD Stereo Codec	Realtek 2.1-channel ALC3252 codec		
Audio I/O Ports	Front Headphone-Out(Gain=0 dB, 1 ohm Input Impedance, function is configurable by audio driver)		
	Rear Line-In/Microphone input (Gain=0 dB ,27-K ohm Input Impedance, function is configurable by audio driver)		
	Rear Line-Out*(Gain=0 dB, 200 ohm Input Impedance, function is configurable by audio driver)		
	All ports are 3.5mm		
Internal Speaker Amplifier	N/A		
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.		
Sampling	8 kHz - 192 kHz		
Wavetable Syntheses	Yes — Uses OS soft wavetable		
Analog Audio	Yes		
# of Channels on Line-Out	Stereo (Left & Right channels)		
Internal Speaker	No		
External Speaker Jack	Yes		



Realtek R1	TL8111HSH -CG	GbE
10/100/1000 NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet) Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface	PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ
	NIC Device Driver Name	PCIe GBE Ethernet Family Controller

Intel° 3168 802.11ac with PCIe x1 WLAN/ Bluetooth® Combo*			
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac		
Interoperability	Wi-Fi certification	Wi-Fi certification	
Frequency Bands	802.11b/g/n	2.402 – 2.482 GHz Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.	



	802.11a/n	4.9 – 4.95 GHz (Japan)		
		5.15 – 5.25 GHz		
		5.25 – 5.35 GHz		
		5.47 – 5.725 GHz		
		5.825 – 5.850 GHz		
		Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)		
Data Rates	• 802.11b:	1, 2, 5.5, 11 Mbps		
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps			
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps			
	• 802.11n:	MCS 0 ~ MCS 15, (20MHz, and 40MHz)		
	• 802.11ac	: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)		
Modulation	Direct Sequen	ce Spread Spectrum		
	BPSK, QPSK, C	CK, 16-QAM, 64-QAM, 256-QAM		
Security ¹	IEEE and V	WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only		
	AES-CCMF	2: 128 bit in hardware		
	• 802.1x au	thentication		
	 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification 			
	• IEEE 802.	11i		
	Cisco Cert	 Cisco Certified Extensions, all versions through CCX4 and CCX Lite 		
	• WAPI			
	¹ Check latest soft	ware/driver release for updates on supported security features.		
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)			
Roaming	802.11r Fast Roaming			
Output Power ²	802.11b: +16dBm minimum			
	• 802.11g: +14dBm minimum			
	802.11a: +14dBm minimum			
	• 802.11n H	IT20(2.4GHz) : +14dBm minimum		
	802.11n HT40(2.4GHz): +12dBm minimum			
	802.11n HT20(5GHz): +14dBm minimum			
	802.11n HT40(5GHz): +14dbii Hillillillillilli 802.11n HT40(5GHz): +12dBm minimum			
		80MHz(5GHz): +11dBm minimum		
	² Maximum output power may vary by country according to local regulations.			
Power Consumption	Transmit: 2.0 W	/ (max)		
	Receive: 1.6 W			
	Idle mode (PSP): 180 mW (WLAN Associated)			
	Idle mode: 50 m	ıW (WLAN unassociated)		



	Connect Standby: 10 mW (WLAN+BT) Radio disabled: 5 mW			
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode			
Receiver Sensitivity ³	802.11b, 1Mbps: -94dBm maximum 802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -88dBm maximum 802.11a, 54Mbps: -74dBm maximum 802.11a, 54Mbps: -74dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 2SS, MCS-0: -81dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum			
	³ Receiver sensitivity is measured at a and a packet error rate of 10% for 802	packet error rate of 8% for 802.11b (CKK modulation) 2.11a/g (OFDM modulation).		
Antenna type	Two embedded dual band 2.4/5 GHz a	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factors	PCI-Express M.2 MiniCard	PCI-Express M.2 MiniCard		
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm			
Weight	Type 2230 : 2.8g Or Type 1630 : 2g	Or		
Operating Voltage	3.3v +/- 9%			
Temperature	Operating: 14° to 158° F (-10° to 70° C) Non-operating: -40° to 176° F (-40° to 80° C)			
Humidity	Operating:10% to 90% (non-condensing)Non-operating:5% to 95% (non-condensing)			
Altitude	Operating: 0 to 10,000 ft (3,048 m) Non-operating: 0 to 50,000 ft (15,240 m)			
LED Activity	LED Amber – Radio OFF; LED White – I	Radio ON		
* Wireless access point and I	nternet service required and not included. <i>I</i>	Availability of public wireless access points limited.		
HP Integrated Module with	Bluetooth 4.0/4.1/4.2 Wireless Technolog	у		
Bluetooth Specification	4.0/4.1/4.2 Compliant			



Frequency Band	2402 to 2480 MHz				
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)				
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps				
		BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels			
		Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)			
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.				
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER		
Legacy	GFSK	-80 dBm	-70 dBm		
	π/4-DQPSK	-80 dBm	-70 dBm		
	8DPSK	-80 dBm	-70 dBm		
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW				
Range	Legacy Up to 33 ft (10 m) BLE Up to 99 ft (30 m)				
Electrical Interface	USB 2.0 compliant				
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software				
Electrical Interface Bluetooth Software Supported Security	Point to Point, Multipoint Pico Nets up to 7 slaves				
	Full support of Bluetooth Security Provisions				
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support				
	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff				
Security	All necessary regulatory approvals for supported countries, including:				
Certifications Bluetooth Profiles Supported	FCC (47 CFR) Part 15C, Section 15.247 & 15.249				
Power Management Certifications	ETS 300 328, ETS 300 826				
	Low Voltage Directiv	Low Voltage Directive IEC950			



Certifications Bluetooth Profiles Supported	UL, CSA, and CE Mark		
Bluetooth Fromes Supported	Serial Port Profile (SPP) ¹		
	Service Discovery Application Profile (SDAP)		
	Dial-Up Networking (DUN) ^{1,2}		
	Generic Object Exchange Profile (GOEP) ^{1,2}		
	Object Push Profile (OPP) ^{1,2}		
	Hard Copy Cable Replacement (HCRP) ^{1,2}		
	Personal Area Networking Profile (PAN) ^{1,2}		
	Human Interface Device Profile (HID) ^{1,2}		
	Hands Free Profile (HFP)		
	Advanced Audio Distribution Profile (A2DP)		
	Audio Video Remote Control Profile (AVRCP)		
Bluetooth V4.1/V4.2 support	V4.1: ESR5/6/7 compliant		
feature	V4.2: ESR8 compliant, LE Secure Connection – Basic.		



After-Market Options (availability may vary by region)

<u>Туре</u>	<u>Description</u>	<u> Part #</u>
Memory	HP 4GB DDR4-2133 DIMM HP 8GB DDR4-2133 DIMM	P1N51AA P1N52AA
Storage	HP 500GB SATA 6.0Gb/s Hard Drive	QK554AA
Graphics	NVIDIA GeForce GT 730 2GB PCIe x8 Card	N3R90AA
Security	HP Business PC Security Lock V2 Kit	N3R93AA
Multimedia	HP Business Headset v2 HP USB Business Speakers v2	N3R89AA T4E61AA
Input	HP USB Keyboard HP Conferencing Keyboard HP USB Conferencing Keyboard HP USB Business Slim Keyboard HP USB Antimicrobial Keyboard and Mouse (China Only)	QY776AA K8P74AA N8N57AA N3R87AA K7X25AA



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Change Log

Date of change:	Version History:		Description of change:
December 5, 2016	From v1 to v2	Update	SuperMulti references deleted
February 1, 2017	From v2 to v3	Update	Software Components and Applications with Windows Section updated. HP BIOS Config Utility (BCU) deleted
April 26, 2017	From v3 to v4	Update	Audio Section Updated
August 7, 2017	From v4 to v5	Update	At a Glance, Processor & Memory sections updated
August 22, 2017	From v5 to v6	Update	Transfer rate fixed on the Memory section
January 18, 2018	From v6 to v7	Update	Environmental data added
March 8, 2018	From v7 to v8	Update	Couple of notes added to (TPM) 2.0 (firmware) in Security Features section
December 19, 2018	From v8 to v9	Update	HP ePrint driver removed from software and HP touchpoint manager from Manageability Typos corrected on Environmental table

